

Zener Voltage Regulators

250 mW SOT-23 Surface Mount

BZX84CxxxET1G Series, SZBZX84CxxxET1G Series

This series of Zener diodes is offered in the convenient, surface mount plastic SOT-23 package. These devices are designed to provide voltage regulation with minimum space requirement. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

Specification Features

- 250 mW Rating on FR-4 or FR-5 Board
- Zener Breakdown Voltage Range 2.4 V to 75 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Peak Power 225 W (8 X 20 μs)
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Mechanical Characteristics

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

POLARITY: Cathode indicated by polarity band

FLAMMABILITY RATING: UL 94 V-0

MAXIMUM RATINGS

| Rating | Symbol | Max | Unit |
|---|-----------------------------------|-------------------|---------------------|
| Peak Power Dissipation @ 20 μs (Note 1) @ $T_L \le 25$ °C | P _{pk} | 225 | W |
| Total Power Dissipation on FR-5 Board, (Note 2) @ T _A = 25°C Derated above 25°C Thermal Resistance, Junction-to-Ambient | P _D | 250 2.0 500 | mW mW/°C °C/W |
| Total Power Dissipation on Alumina Substrate, (Note 3) @ T _A = 25°C Derated above 25°C Thermal Resistance, Junction–to–Ambient | P_{D} $R_{	heta JA}$ | 300 2.4 417 | mW mW/°C °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -65 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

- 1. Nonrepetitive current pulse per Figure 9.
- 2. FR-5 = 1.0 X 0.75 X 0.62 in.
- 3. Alumina = 0.4 X 0.3 X 0.024 in, 99.5% alumina.



SOT-23 CASE 318 STYLE 8



MARKING DIAGRAM



xxx = Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|---------------------|-------------------------|
| BZX84CxxxET1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| SZBZX84CxxxET1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| BZX84CxxxET3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |
| SZBZX84CxxxET3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 2.

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

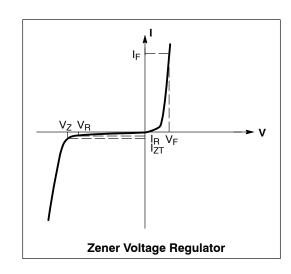
DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.90$ V Max. @ $I_F = 10$ mA)

| Symbol | Parameter |
|-----------------|---|
| V _Z | Reverse Zener Voltage @ I _{ZT} |
| I _{ZT} | Reverse Current |
| Z _{ZT} | Maximum Zener Impedance @ I _{ZT} |
| I _R | Reverse Leakage Current @ V _R |
| V _R | Reverse Voltage |
| lF | Forward Current |
| V _F | Forward Voltage @ I _F |
| ΘV_Z | Maximum Temperature Coefficient of V _Z |
| С | Max. Capacitance @ V _R = 0 and f = 1 MHz |



ELECTRICAL CHARACTERISTICS

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.90 \text{ V}$ Max. @ $I_F = 10 \text{ mA}$)

| | | | V _{Z1} (V) _{ZT1} = 5 (Note 4) | mΑ | Z _{ZT1} (Ω) @ I _{ZT1} | @ I _{ZT} | (V) 2 = 1 A te 4) | Z _{ZT2} (Ω) . @ I _{ZT2} | V _{Z3} @ I _{ZT3} // (Not | ١. | Z _{ZT3} (Ω) @ | Ma Reve Leal Cur | erse (age | θ _\ (m\ Θ I _{ZT1} = | //k) D | C (pF) @ V _R = 0 |
|---------------|-------------------|-----|---|-----|---|-------------------|----------------------------|---|---|-----|------------------------------|---------------------------|--------------------|--|-----------|-----------------------------------|
| Device* | Device Marking | Min | Nom | Max | = 5 mA | Min | Max | = 1 mA | Min | Max | I _{ZT3} = 20 mA | I _R @ | V _R (V) | Min | Max | f = 1 MHz |
| BZX84C2V4ET1G | BA1 | 2.2 | 2.4 | 2.6 | 100 | 1.7 | 2.1 | 600 | 2.6 | 3.2 | 50 | 50 | 1.0 | -3.5 | 0 | 450 |
| BZX84C6V2ET1G | BB3 | 5.8 | 6.2 | 6.6 | 10 | 5.6 | 6.6 | 150 | 5.8 | 6.8 | 6 | 3.0 | 4.0 | 0.4 | 3.7 | 185 |

DISCONTINUED (Note 5)

| BZX84C2V7ET1G | BA2 | 2.5 | 2.7 | 2.9 | 100 | 1.9 | 2.4 | 600 | 3.0 | 3.6 | 50 | 20 | 1.0 | -3.5 | 0 | 450 |
|---------------|-----|------|-----|------|-----|------|------|-----|------|------|----|------|------|------|------|-----|
| BZX84C13ET1G | BC2 | 12.4 | 13 | 14.1 | 30 | 12.3 | 14 | 170 | 12.5 | 14.2 | 15 | 0.1 | 8.0 | 7.0 | 11 | 120 |
| BZX84C16ET1G | BC4 | 15.3 | 16 | 17.1 | 40 | 15.2 | 17 | 200 | 15.4 | 17.2 | 20 | 0.05 | 11.2 | 10.4 | 14 | 105 |
| BZX84C22ET1G | BC7 | 20.8 | 22 | 23.3 | 55 | 20.7 | 23.2 | 250 | 20.9 | 23.4 | 25 | 0.05 | 15.4 | 16.4 | 20 | 85 |
| BZX84C10ET1G | BB8 | 9.4 | 10 | 10.6 | 20 | 9.3 | 10.6 | 150 | 9.4 | 10.7 | 10 | 0.2 | 7.0 | 4.5 | 8.0 | 130 |
| BZX84C7V5ET1G | BB5 | 7.0 | 7.5 | 7.9 | 15 | 6.9 | 7.9 | 80 | 7.0 | 8.0 | 6 | 1.0 | 5.0 | 2.5 | 5.3 | 140 |
| BZX84C5V1ET1G | BB1 | 4.8 | 5.1 | 5.4 | 60 | 4.2 | 5.3 | 480 | 5.0 | 5.9 | 15 | 2.0 | 2.0 | -2.7 | 1.2 | 225 |
| BZX84C4V3ET1G | BA7 | 4.0 | 4.3 | 4.6 | 90 | 3.3 | 4.0 | 600 | 4.4 | 5.1 | 30 | 3.0 | 1.0 | -3.5 | 0 | 450 |
| BZX84C6V8ET1G | BB4 | 6.4 | 6.8 | 7.2 | 15 | 6.3 | 7.2 | 80 | 6.4 | 7.4 | 6 | 2.0 | 4.0 | 1.2 | 4.5 | 155 |
| BZX84C3V3ET1G | BA4 | 3.1 | 3.3 | 3.5 | 95 | 2.3 | 2.9 | 600 | 3.6 | 4.2 | 40 | 5.0 | 1.0 | -3.5 | 0 | 450 |
| BZX84C18ET1G | BC5 | 16.8 | 18 | 19.1 | 45 | 16.7 | 19 | 225 | 16.9 | 19.2 | 20 | 0.05 | 12.6 | 12.4 | 16 | 100 |
| BZX84C5V6ET1G | BB2 | 5.2 | 5.6 | 6.0 | 40 | 4.8 | 6.0 | 400 | 5.2 | 6.3 | 10 | 1.0 | 2.0 | -2 | 2.5 | 200 |
| BZX84C3V0ET1G | BA3 | 2.8 | 3.0 | 3.2 | 95 | 2.1 | 2.7 | 600 | 3.3 | 3.9 | 50 | 10 | 1.0 | -3.5 | 0 | 450 |
| BZX84C8V2ET1G | BB6 | 7.7 | 8.2 | 8.7 | 15 | 7.6 | 8.7 | 80 | 7.7 | 8.8 | 6 | 0.7 | 5.0 | 3.2 | 6.2 | 135 |
| BZX84C15ET1G | BC3 | 13.8 | 15 | 15.6 | 30 | 13.7 | 15.5 | 200 | 13.9 | 15.7 | 20 | 0.05 | 10.5 | 9.2 | 13 | 110 |
| BZX84C11ET1G | BB9 | 10.4 | 11 | 11.6 | 20 | 10.2 | 11.6 | 150 | 10.4 | 11.8 | 10 | 0.1 | 8.0 | 5.4 | 9.0 | 130 |
| BZX84C20ET1G | BC6 | 18.8 | 20 | 21.2 | 55 | 18.7 | 21.1 | 225 | 18.9 | 21.4 | 20 | 0.05 | 14 | 14.4 | 18 | 85 |
| BZX84C24ET1G | BC8 | 22.8 | 24 | 25.6 | 70 | 22.7 | 25.5 | 250 | 22.9 | 25.7 | 25 | 0.05 | 16.8 | 18.4 | 22 | 80 |
| BZX84C3V6ET1G | BA5 | 3.4 | 3.6 | 3.8 | 90 | 2.7 | 3.3 | 600 | 3.9 | 4.5 | 40 | 5.0 | 1.0 | -3.5 | 0 | 450 |
| BZX84C4V7ET1G | BA9 | 4.4 | 4.7 | 5.0 | 80 | 3.7 | 4.7 | 500 | 4.5 | 5.4 | 15 | 3.0 | 2.0 | -3.5 | 0.2 | 260 |
| BZX84C9V1ET1G | BB7 | 8.5 | 9.1 | 9.6 | 15 | 8.4 | 9.6 | 100 | 8.5 | 9.7 | 8 | 0.5 | 6.0 | 3.8 | 7.0 | 130 |
| BZX84C3V9ET1G | BA6 | 3.7 | 3.9 | 4.1 | 90 | 2.9 | 3.5 | 600 | 4.1 | 4.7 | 30 | 3.0 | 1.0 | -3.5 | -2.5 | 450 |

ELECTRICAL CHARACTERISTICS

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.90 \text{ V Max.}$ @ $I_F = 10 \text{ mA}$)

| | | | _{Z1} Belo _{ZT1} = 2 | | Z _{ZT1} Below @ I _{ZT1} | @ I _Z | Below 2T2 = mA | Z _{ZT2} Below . @ I _{ZT4} | V _{Z3} E @ I _{ZT3} | = 10 m- | Z _{ZT3} Below @ I _{ZT3} | Ma Revo Leak Curi | erse kage | θ _\ (m\ Bel @ I _{Z1} m | //k) low - ₁ = 2 | C (pF) @ V _R = |
|--------------|-------------------|-----|--|-----|---|------------------|----------------------|---|---|---------|---|----------------------------|--------------------|--|-----------------------------------|------------------------------|
| Device* | Device Marking | Min | Nom | Max | = 2 mA | Min | Max | = 0.5 mA | Min | Max | = 10 mA | I _R @ | V _R (V) | Min | Max | f = 1 MHz |
| BZX84C30ET1G | BD1 | 28 | 30 | 32 | 80 | 27.8 | 32 | 300 | 28.1 | 32.4 | 50 | 0.05 | 21 | 24.4 | 29.4 | 70 |

DISCONTINUED (Note 5)

| BZX84C47ET1G | BD5 | 44 | 47 | 50 | 170 | 43.7 | 50 | 375 | 44.1 | 50.5 | 90 | 0.05 | 32.9 | 42 | 51.8 | 40 |
|--------------|-----|------|----|------|-----|------|------|-----|------|------|-----|------|------|------|------|-----|
| BZX84C56ET1G | BD7 | 52 | 56 | 60 | 200 | 51.5 | 60 | 425 | 52.1 | 60.8 | 110 | 0.05 | 39.2 | 52.2 | 63.8 | 40 |
| BZX84C62ET1G | BD8 | 58 | 62 | 66 | 215 | 57.4 | 66 | 450 | 58.2 | 67 | 120 | 0.05 | 43.4 | 58.8 | 71.6 | 35 |
| BZX84C43ET1G | BK6 | 40 | 43 | 46 | 150 | 39.7 | 46 | 375 | 40.1 | 46.5 | 80 | 0.05 | 30.1 | 37.6 | 46.6 | 40 |
| BZX84C36ET1G | BD3 | 34 | 36 | 38 | 90 | 33.8 | 38 | 350 | 34.1 | 38.4 | 60 | 0.05 | 25.2 | 30.4 | 37.4 | 70 |
| BZX84C27ET1G | BC9 | 25.1 | 27 | 28.9 | 80 | 25 | 28.9 | 300 | 25.2 | 29.3 | 45 | 0.05 | 18.9 | 21.4 | 25.3 | 70 |
| BZX84C39ET1G | BD4 | 37 | 39 | 41 | 130 | 36.7 | 41 | 350 | 37.1 | 41.5 | 70 | 0.05 | 27.3 | 33.4 | 41.2 | 45 |
| BZX84C33ET1G | BD2 | 31 | 33 | 35 | 80 | 30.8 | 35 | 325 | 31.1 | 35.4 | 55 | 0.05 | 23.1 | 27.4 | 33.4 | 70 |
| BZX84C12ET1G | BC1 | 11.4 | 12 | 12.7 | 25 | 11.2 | 12.7 | 150 | 11.4 | 12.9 | 10 | 0.1 | 8.0 | 6.0 | 10 | 130 |
| BZX84C51ET1G | BD6 | 48 | 51 | 54 | 180 | 47.6 | 54 | 400 | 48.1 | 54.6 | 100 | 0.05 | 35.7 | 46.6 | 57.2 | 40 |
| BZX84C75ET1G | BE1 | 70 | 75 | 79 | 255 | 69.4 | 79 | 500 | 70.3 | 80.2 | 140 | 0.05 | 52.5 | 73.4 | 88.6 | 35 |
| BZX84C68ET1G | BD9 | 64 | 68 | 72 | 240 | 63.4 | 72 | 475 | 64.2 | 73.2 | 130 | 0.05 | 47.6 | 65.6 | 79.8 | 35 |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{*} Include SZ-prefix devices where applicable.

^{4.} Zener voltage is measured with a pulse test current I_Z at an ambient temperature of 25°C

^{5.} **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

TYPICAL CHARACTERISTICS

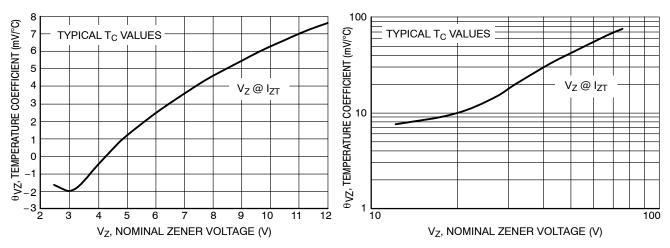


Figure 1. Temperature Coefficients (Temperature Range – 55°C to +150°C)

Figure 2. Temperature Coefficients (Temperature Range – 55°C to +150°C)

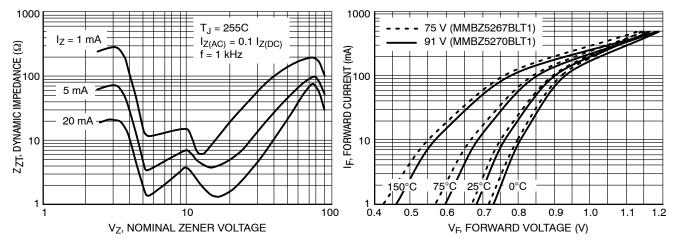


Figure 3. Effect of Zener Voltage on Zener Impedance

Figure 4. Typical Forward Voltage

TYPICAL CHARACTERISTICS

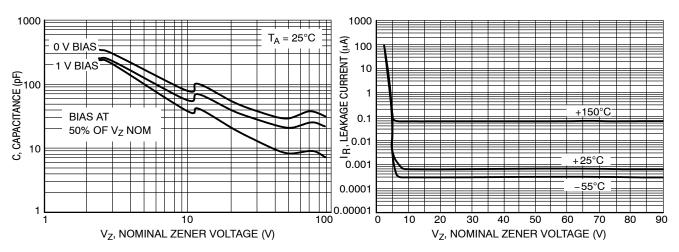


Figure 5. Typical Capacitance

Figure 6. Typical Leakage Current

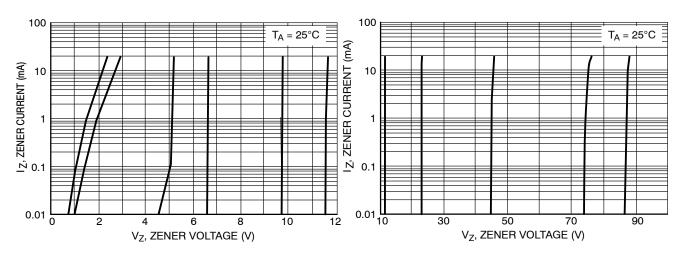


Figure 7. Zener Voltage versus Zener Current (V_Z Up to 12 V)

Figure 8. Zener Voltage versus Zener Current (12 V to 91 V)

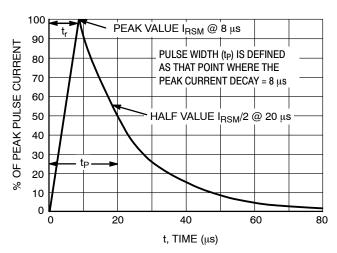


Figure 9. $8 \times 20 \mu s$ Pulse Waveform

MILLIMETERS

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40





SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

DATE 14 AUG 2024

MAX

1.11

0.10

0.50

0.20

3.04

1.40

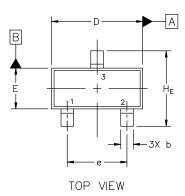
2.04

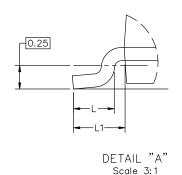
0.55

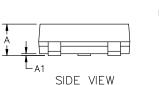
0.69

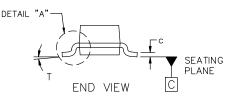
2.64

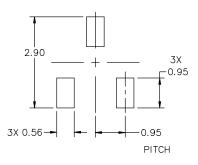
10°











NOTES:

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Τ

- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package



* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

| DOCUMENT NUMBER: | 98ASB42226B | Electronic versions are uncontrolled except when accessed directly from the Document I Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | | | |
|------------------|--------------------------|---|-------------|--|--|--|--|
| DESCRIPTION: | SOT-23 (TO-236) 2.90x1.3 | 0x1.00 1.90P | PAGE 1 OF 2 | | | | |

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries, onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

SOT-23 (TO-236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

| STYLE 1 THRU 5: CANCELLED | STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR | STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE | 1 | |
|---|---|---|--|------------------|---|
| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE | STYLE 13: | STYLE 14: |
| PIN 1. ANODE | PIN 1. DRAIN | PIN 1. ANODE | | PIN 1. SOURCE | PIN 1. CATHODE |
| 2. ANODE | 2. SOURCE | 2. CATHODE | | 2. DRAIN | 2. GATE |
| 3. CATHODE | 3. GATE | 3. CATHODE-ANODE | | 3. GATE | 3. ANODE |
| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: | STYLE 19: | STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE |
| PIN 1. GATE | PIN 1. ANODE | PIN 1. NO CONNECTION | PIN 1. NO CONNECTION | N PIN 1. CATHODE | |
| 2. CATHODE | 2. CATHODE | 2. ANODE | 2. CATHODE | 2. ANODE | |
| 3. ANODE | 3. CATHODE | 3. CATHODE | 3. ANODE | 3. CATHODE-ANODI | |
| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: | STYLE 25: | STYLE 26: |
| PIN 1. GATE | PIN 1. RETURN | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE |
| 2. SOURCE | 2. OUTPUT | 2. ANODE | 2. DRAIN | 2. CATHODE | 2. ANODE |
| 3. DRAIN | 3. INPUT | 3. CATHODE | 3. SOURCE | 3. GATE | 3. NO CONNECTION |
| STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE | STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE | | | | |

| DOCUMENT NUMBER: | 98ASB42226B | Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | | | | |
|------------------|--------------------------|---|-------------|--|--|--|--|--|
| DESCRIPTION: | SOT-23 (TO-236) 2.90x1.3 | 0x1.00 1.90P | PAGE 2 OF 2 | | | | | |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales